

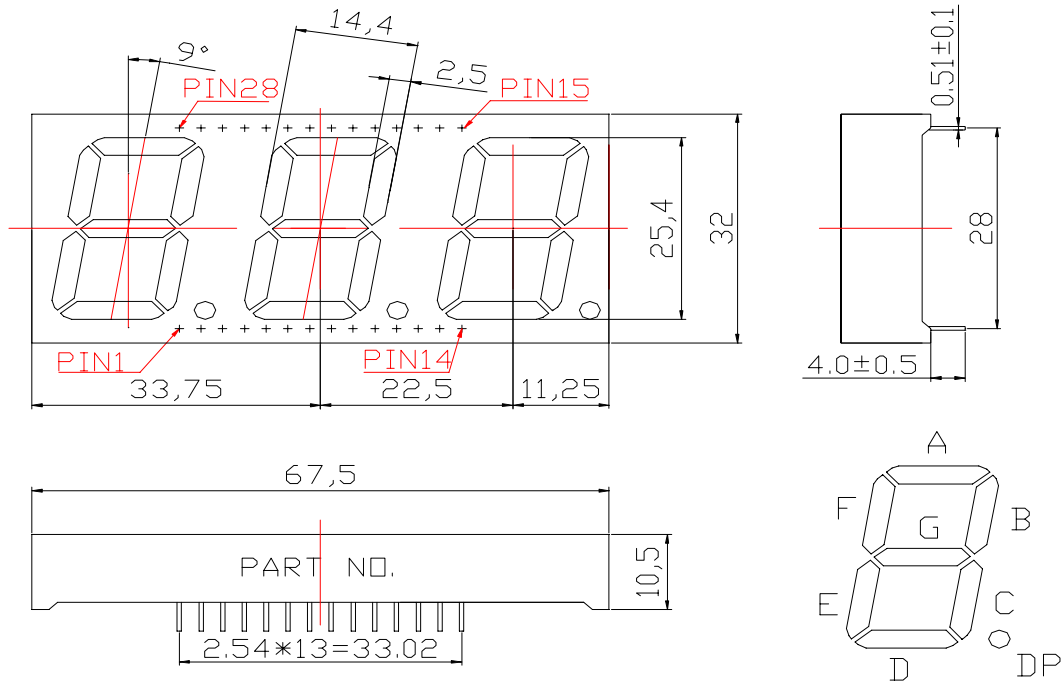
WCN3-00A0SR-A11

SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei 2016-7-8	Athena		
REVISION RECORD A1: New Version issued and Change Luminous Intensity Sorting(2016-7-8)			

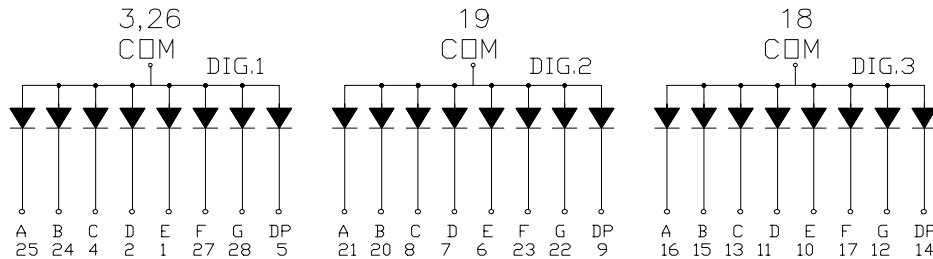
**REVISION: A1**

Outer Dimension:



Notes: Unless otherwise stated, The tolerance is $\pm 0.25\text{mm}$.

Circuit Diagram:



Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION	PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode DIG.1 E	8	Cathode DIG.2 C	15	Cathode DIG.3 B	22	Cathode DIG.2 G
2	Cathode DIG.1 D	9	Cathode DIG.2 DP	16	Cathode DIG.3 A	23	Cathode DIG.2 F
3	Common DIG.1	10	Cathode DIG.3 E	17	Cathode DIG.3 F	24	Cathode DIG.1 B
4	Cathode DIG.1 C	11	Cathode DIG.3 D	18	Common DIG.3	25	Cathode DIG.1A
5	Cathode DIG.1 DP	12	Cathode DIG.3 G	19	Common DIG.2	26	Common DIG.1
6	Cathode DIG.2 E	13	Cathode DIG.3 C	20	Cathode DIG.2 B	27	Cathode DIG.1 F
7	Cathode DIG.2 D	14	Cathode DIG.3 DP	21	Cathode DIG.2 A	28	Cathode DIG.1G

■ **Features:**

- High Reliability
- Color: Red
- Low Power Requirement
- Easy Assembly

■ **Description:**

- Three Digit LED Display
- Digit Height:25.4mm(1.0")
- Black Face and Milky Segment

■ **Absolute Maximum Rating (Ta=25°C):**

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P_d	—	Red	65	mW
Forward Current Per Segment	I_F	—	Red	25	mA
Peak Forward Current Per Segment	I_{FP}	1/10 Duty 10KHz	Red	100	mA
Reverse Voltage Per Segment	V_R	—	Red	5	V
Operating Temperature Range	T_{opr}	—	—	-35~+85	°C
Storage Temperature Range	T_{stg}	—	—	-35~+85	°C

■ **Electrical/Optical Characteristics Rating(Ta=25°C)**

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V_F	$I_F=20mA$	Per Segment	—	2.0	2.6	V
Reverse Current	I_R	$V_R=5V$	Per Segment	—	—	100	μA
Luminous Intensity	I_V	$I_F=10mA$	Per Segment	6101	9500	15250	μcd
Peak Emission Wave Length	λ_P	$I_F=20mA$	Per Segment	—	638	—	nm
	λ_D			—	633	—	
Spectral Line Half Width	$\Delta \lambda$	$I_F=20mA$	Per Segment	—	30	—	nm
Luminous Intensity Matching Ratio (Segment to Segment)	I_{v-m}	$I_F=20mA$	—	—	—	1.2:1	

■ **Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)**

Rank	Symbol	Condition	Min	Max	Unit
N	N	$I_F=10mA$	6101	7200	μcd
O	O	$I_F=10mA$	7201	8500	μcd
P	P	$I_F=10mA$	8501	10500	μcd
Q	Q	$I_F=10mA$	10501	12800	μcd
R	R	$I_F=10mA$	12801	15250	μcd

■ **Soldering Conditions: Soldering Temp. $\leq +260^\circ C$, Soldering Time. $\leq 3sec$.
(at 2mm Distance from The Case of Reflector Edge)**

■ **Typical Elector-Optical Characteristics Curve:**

Fig 1. Forward Current vs. Forward Voltage

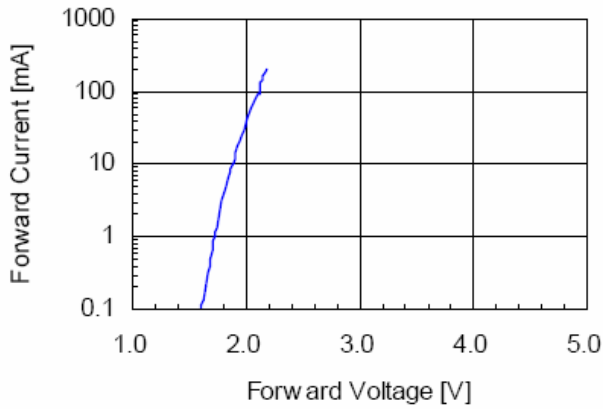


Fig 2. Relative Intensity vs. Forward Current

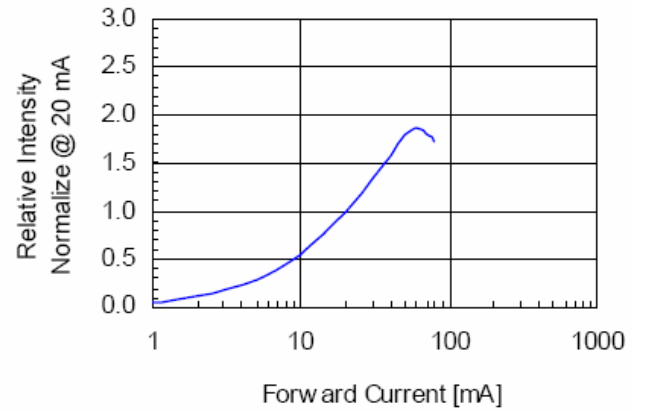


Fig 3. Forward Voltage vs. Temperature

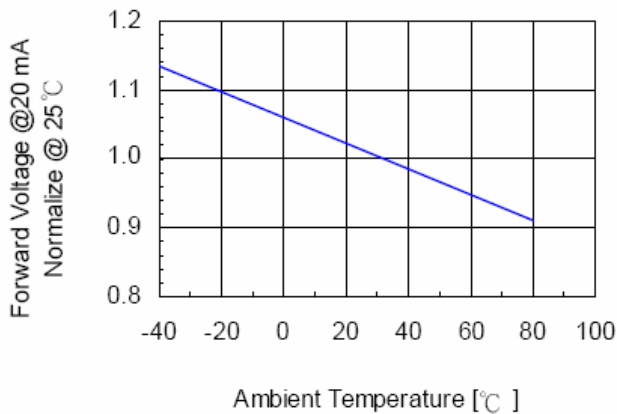


Fig 4. Relative Intensity vs. Temperature

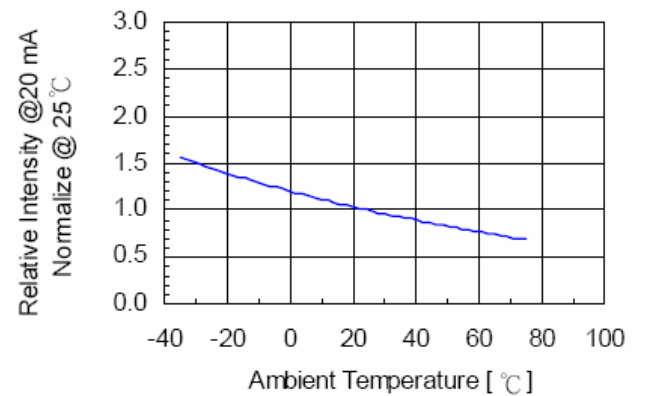
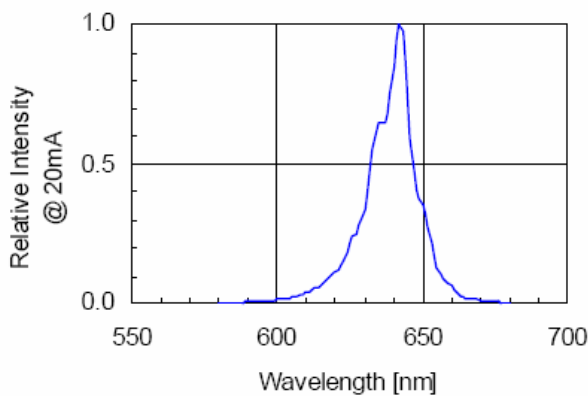


Fig 5. Relative Intensity vs. Wavelength



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T_a = UNDER ROOM TEMPERATURE $I_F = I_{F \max}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION $85^\circ\text{C} \sim 25^\circ\text{C} \sim -35^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES $85 \pm 5^\circ\text{C} \sim -35 \pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10±1sec.

Packing method A:

20pcs / Red Expandable Polyethylene.

100 pcs / Box(360*175*130mm).

600 pcs / Carton(550*380*280mm).

Packing method B:

7 pcs / IC Tube(520*37*21).

168 pcs / Box(537*175*125mm).

672 pcs / Carton(550*380*280mm)